

NPN Silicon Germanium RF Transistor*

- High gain low noise RF transistor
- Provides outstanding performance for a wide range of wireless applications
- Ideal for CDMA and WLAN applications
- Outstanding noise figure $F = 0.65$ dB at 1.8 GHz
Outstanding noise figure $F = 1.2$ dB at 6 GHz
- High maximum stable gain
 $G_{ms} = 23$ dB at 1.8 GHz
- Gold metallization for extra high reliability
- 70 GHz f_T -Silicon Germanium technology
- Pb-free (RoHS compliant) package ¹⁾
- Qualified according AEC Q101

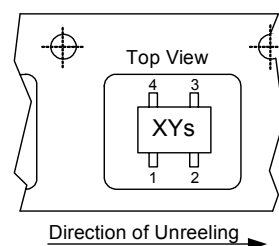
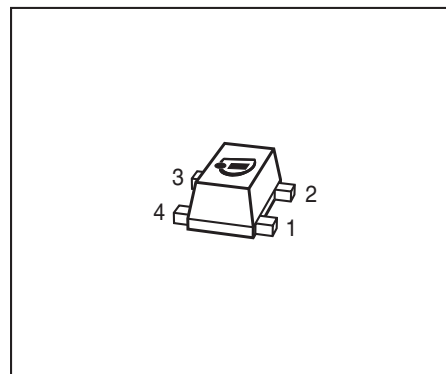
* Short term description



ESD (Electrostatic discharge) sensitive device, observe handling precaution!

Type	Marking	Pin Configuration						Package
BFP640F	R4s	1=B	2=E	3=C	4=E	-	-	TSFP-4

¹Pb-containing package may be available upon special request



Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-emitter voltage $T_A > 0^\circ\text{C}$ $T_A \leq 0^\circ\text{C}$	V_{CEO}	4 3.7	V
Collector-emitter voltage	V_{CES}	13	
Collector-base voltage	V_{CBO}	13	
Emitter-base voltage	V_{EBO}	1.2	
Collector current	I_{C}	50	mA
Base current	I_{B}	3	
Total power dissipation ¹⁾ $T_S \leq 92^\circ\text{C}$	P_{tot}	200	mW
Junction temperature	T_{j}	150	$^\circ\text{C}$
Ambient temperature	T_{A}	-65 ... 150	
Storage temperature	T_{stg}	-65 ... 150	

Thermal Resistance

Parameter	Symbol	Value	Unit
Junction - soldering point ²⁾	R_{thJS}	≤ 290	K/W

Electrical Characteristics at $T_A = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
DC Characteristics					
Collector-emitter breakdown voltage $I_C = 1 \text{ mA}, I_B = 0$	$V_{(\text{BR})\text{CEO}}$	4	4.5	-	V
Collector-emitter cutoff current $V_{\text{CE}} = 13 \text{ V}, V_{\text{BE}} = 0$	I_{CES}	-	-	30	μA
Collector-base cutoff current $V_{\text{CB}} = 5 \text{ V}, I_{\text{E}} = 0$	I_{CBO}	-	-	100	nA
Emitter-base cutoff current $V_{\text{EB}} = 0.5 \text{ V}, I_{\text{C}} = 0$	I_{EBO}	-	-	3	μA
DC current gain $I_C = 30 \text{ mA}, V_{\text{CE}} = 3 \text{ V}, \text{puls measured}$	h_{FE}	110	180	270	-

¹⁾ T_{S} is measured on the collector lead at the soldering point to the pcb

²⁾ For calculation of R_{thJA} please refer to Application Note Thermal Resistance

Electrical Characteristics at $T_A = 25^\circ\text{C}$, unless otherwise specified

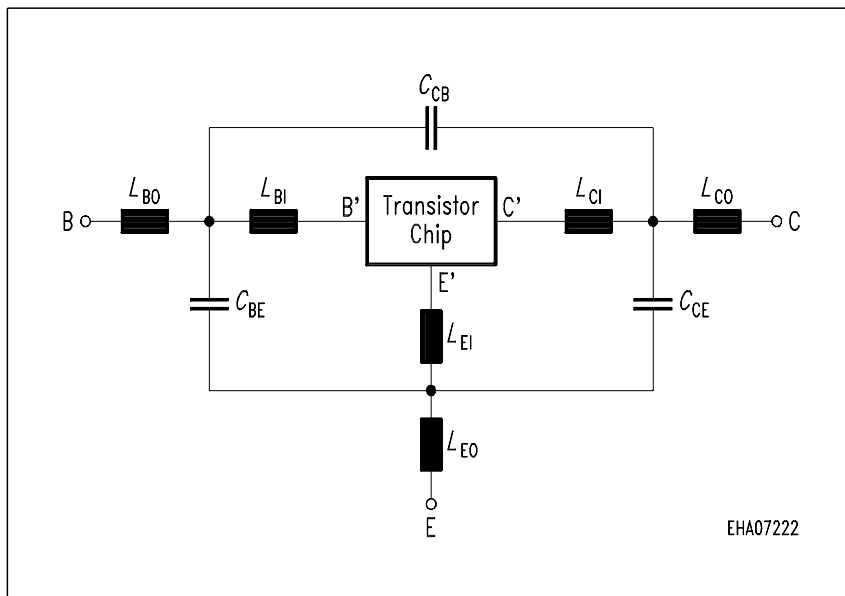
Parameter	Symbol	Values			Unit
		min.	typ.	max.	
AC Characteristics (verified by random sampling)					
Transition frequency $I_C = 30\text{ mA}$, $V_{CE} = 3\text{ V}$, $f = 1\text{ GHz}$	f_T	30	40	-	GHz
Collector-base capacitance $V_{CB} = 3\text{ V}$, $f = 1\text{ MHz}$, $V_{BE} = 0$, emitter grounded	C_{cb}	-	0.09	0.2	pF
Collector emitter capacitance $V_{CE} = 3\text{ V}$, $f = 1\text{ MHz}$, $V_{BE} = 0$, base grounded	C_{ce}	-	0.18	-	
Emitter-base capacitance $V_{EB} = 0.5\text{ V}$, $f = 1\text{ MHz}$, $V_{CB} = 0$, collector grounded	C_{eb}	-	0.5	-	
Noise figure $I_C = 5\text{ mA}$, $V_{CE} = 3\text{ V}$, $f = 1.8\text{ GHz}$, $Z_S = Z_{Sopt}$ $I_C = 5\text{ mA}$, $V_{CE} = 3\text{ V}$, $f = 6\text{ GHz}$, $Z_S = Z_{Sopt}$	F	- -	0.65 1.2	- -	dB
Power gain, maximum stable ¹⁾ $I_C = 30\text{ mA}$, $V_{CE} = 3\text{ V}$, $Z_S = Z_{Sopt}$, $Z_L = Z_{Lopt}$, $f = 1.8\text{ GHz}$	G_{ms}	-	23	-	dB
Power gain, maximum available ¹⁾ $I_C = 30\text{ mA}$, $V_{CE} = 3\text{ V}$, $Z_S = Z_{Sopt}$, $Z_L = Z_{Lopt}$, $f = 6\text{ GHz}$	G_{ma}	-	12	-	dB
Transducer gain $I_C = 30\text{ mA}$, $V_{CE} = 3\text{ V}$, $Z_S = Z_L = 50\ \Omega$, $f = 1.8\text{ GHz}$ $f = 6\text{ GHz}$	$ S_{21e} ^2$	- -	20.5 10	- -	dB
Third order intercept point at output ²⁾ $V_{CE} = 3\text{ V}$, $I_C = 30\text{ mA}$, $Z_S = Z_L = 50\ \Omega$, $f = 1.8\text{ GHz}$	IP_3	-	27.5	-	dBm
1dB Compression point at output $I_C = 30\text{ mA}$, $V_{CE} = 3\text{ V}$, $Z_S = Z_L = 50\ \Omega$, $f = 1.8\text{ GHz}$	P_{-1dB}	-	13.5	-	

¹⁾ $G_{ma} = |S_{21e}| / |S_{12e}| (k - (k^2 - 1)^{1/2})$, $G_{ms} = |S_{21e}| / |S_{12e}|$
²⁾ IP_3 value depends on termination of all intermodulation frequency components.
Termination used for this measurement is $50\ \Omega$ from 0.1 MHz to 6 GHz

SPICE Parameter (Gummel-Poon Model, Berkley-SPICE 2G.6 Syntax):
Transistor Chip Data:

IS =	0.22	fA	BF =	450	-	NF =	1.025	-
VAF =	1000	V	IKF =	0.15	A	ISE =	21	fA
NE =	2	-	BR =	55	-	NR =	1	-
VAR =	2	V	IKR =	3.8	mA	ISC =	400	fA
NC =	1.8	-	RB =	3.129	Ω	IRB =	1.522	mA
RBM =	2.707	Ω	RE =	0.6	-	RC =	3.061	Ω
CJE =	227.6	fF	VJE =	0.8	V	MJE =	0.3	-
TF =	1.8	ps	XTF =	10	-	VTF =	1.5	V
ITF =	0.4	A	PTF =	0	deg	CJC =	67.43	fF
VJC =	0.6	V	MJC =	0.5	-	XCJC =	1	-
TR =	0.2	ns	CJS =	93.4	fF	VJS =	0.6	V
MJS =	0.27	-	XTB =	-1.42	-	EG =	1.078	eV
XTI =	3	-	FC =	0.8	-	TNOM	298	K
AF =	2	-	KF =	7.291E-11	-			
TITF1	-0.0065	-	TITF2	1.0E-5	-			

All parameters are ready to use, no scaling is necessary.

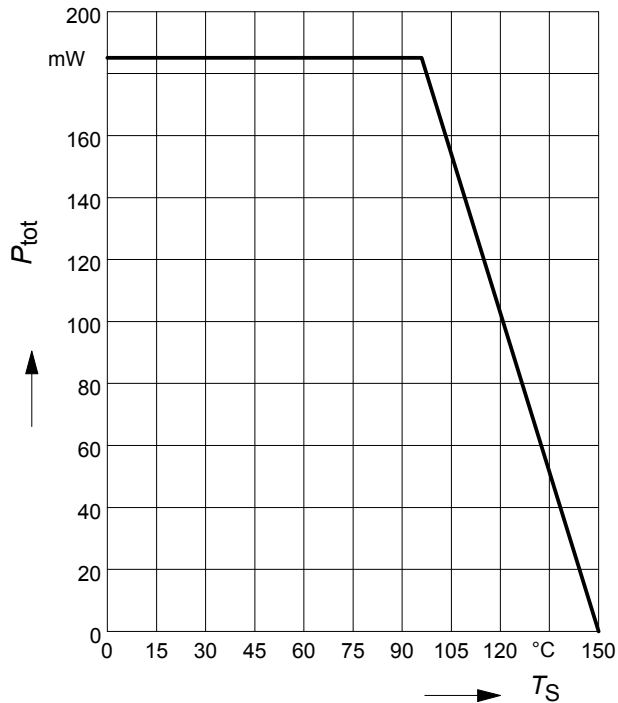
Package Equivalent Circuit:


For examples and ready to use parameters please contact your local Infineon Technologies distributor or sales office to obtain a Infineon Technologies CD-ROM or see Internet: <http://www.infineon.com>

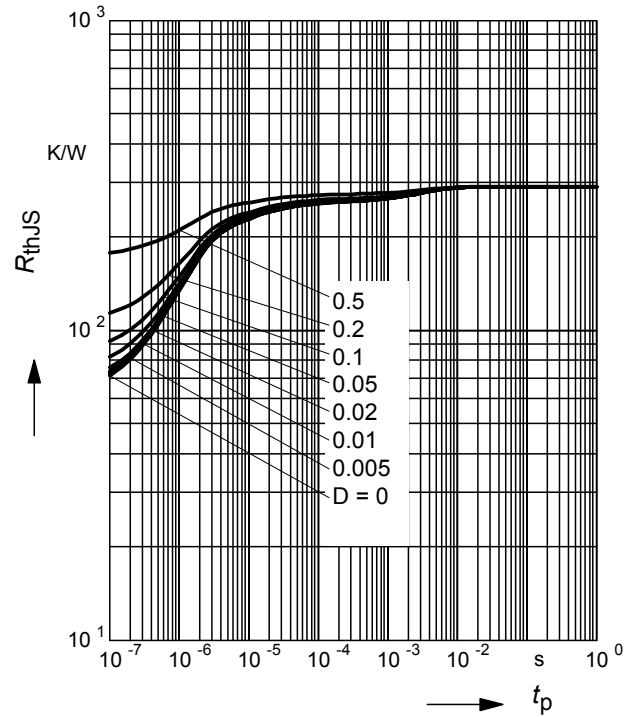
LBO =	0.22	nH
LEO =	0.28	nH
LCO =	0.22	nH
LBI =	0.42	nH
LEI =	0.26	nH
LCI =	0.35	nH
CBE =	34	fF
CBC =	2	fF
CCE =	33	fF
KBO-EO	=0.1	-
KBO-CO	=0.01	-
KEO-CO	=0.11	-
KCI-EI	= 0.2	-
KBI-CI	= -0.08	-
KBI-EI	= -0.05	-
RLBI =	0.15	Ω
RLEI =	0.11	Ω
RLCI =	0.13	Ω

Valid up to 6GHz

Total power dissipation $P_{\text{tot}} = f(T_S)$

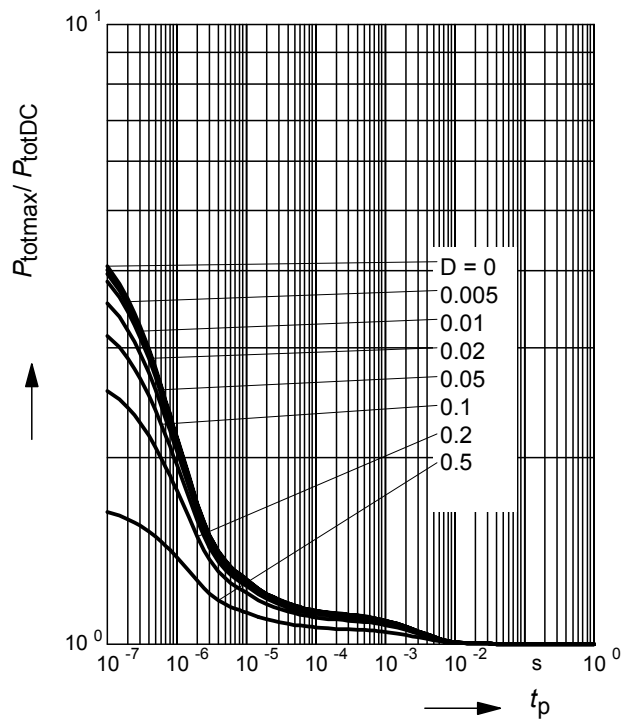


Permissible Pulse Load $R_{\text{thJS}} = f(t_p)$



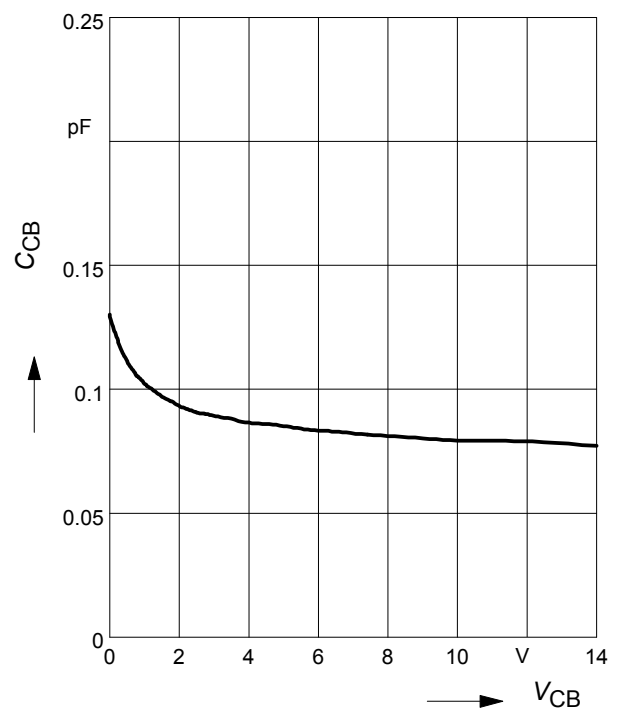
Permissible Pulse Load

$$P_{\text{totmax}}/P_{\text{totDC}} = f(t_p)$$



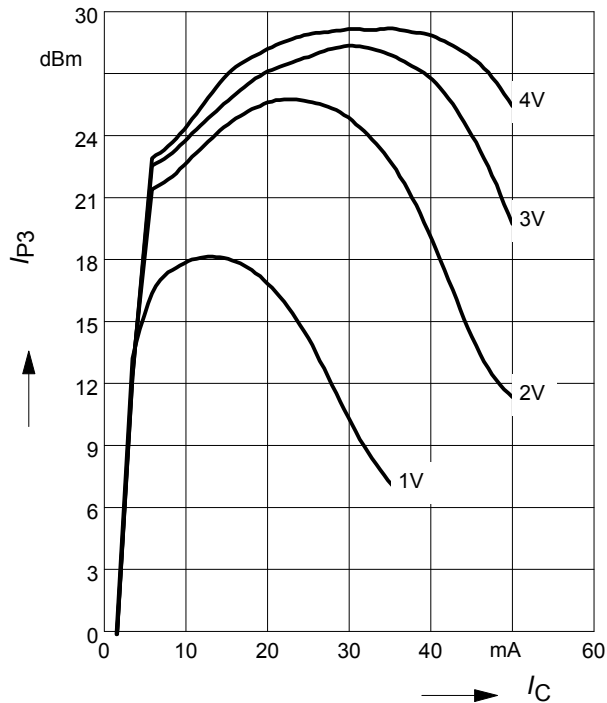
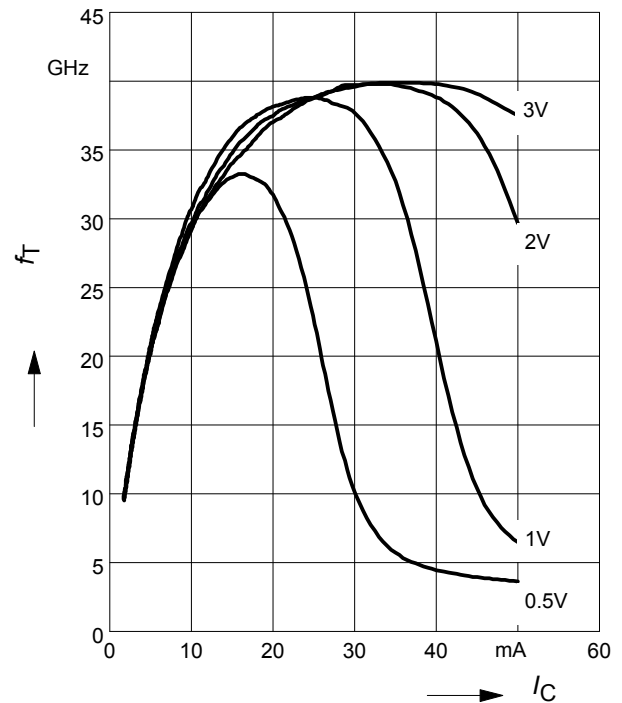
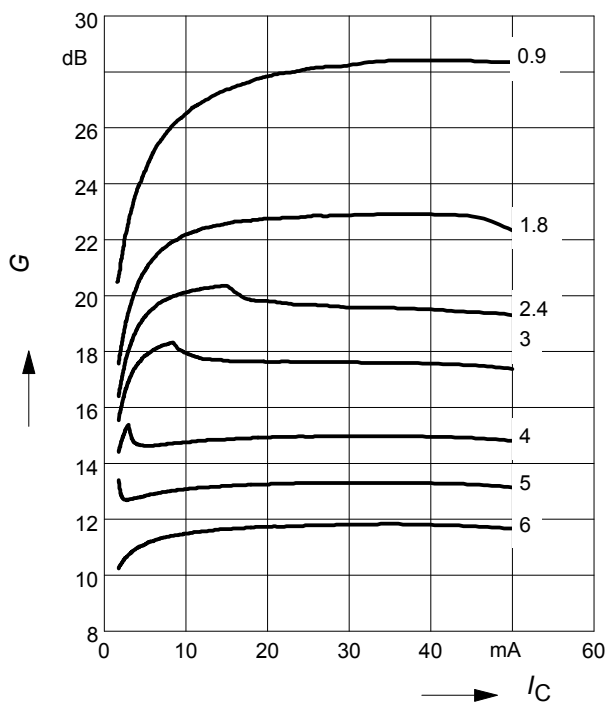
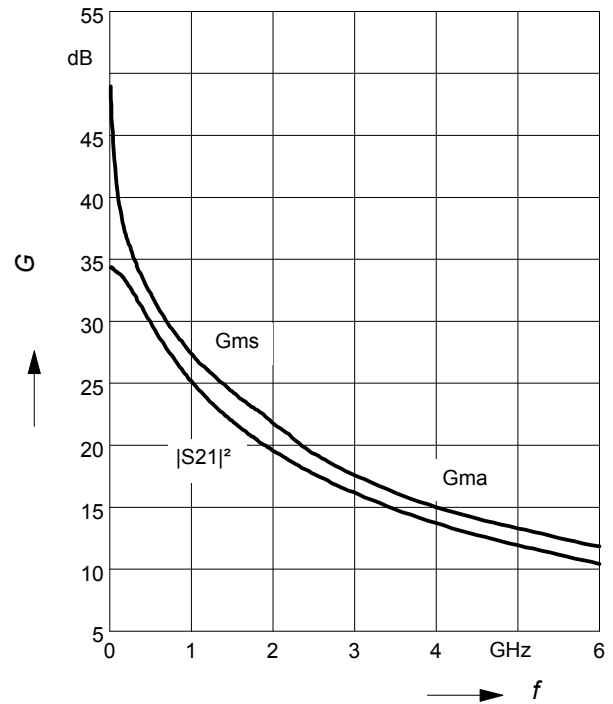
Collector-base capacitance $C_{\text{cb}} = f(V_{\text{CB}})$

$f = 1\text{MHz}$



Third order Intercept Point $IP_3 = f(I_C)$

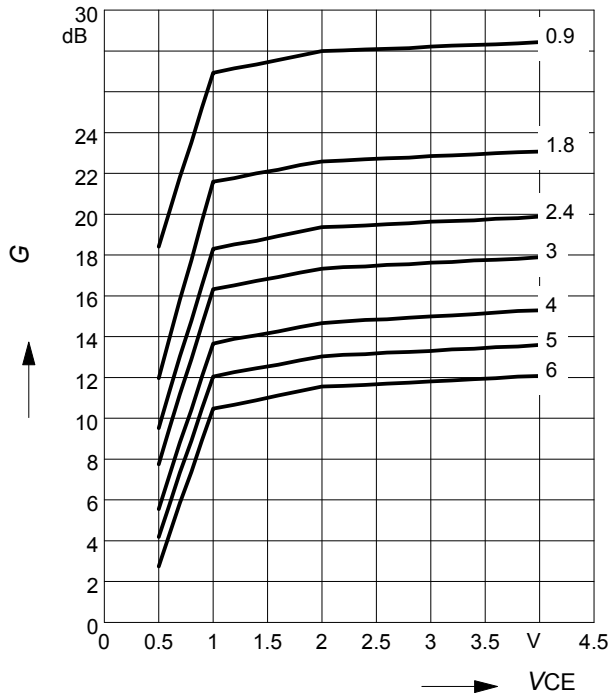
 (Output, $Z_S = Z_L = 50\Omega$)

 V_{CE} = parameter, $f = 1.8\text{ GHz}$

Transition frequency $f_T = f(I_C)$
 $f = 1\text{ GHz}$
 V_{CE} = parameter

Power gain $G_{ma}, G_{ms} = f(I_C)$
 $V_{CE} = 3\text{ V}$
 f = parameter

Power Gain $G_{ma}, G_{ms} = f(f)$
 $|S_{21}|^2 = f(f)$
 $V_{CE} = 3\text{ V}, I_C = 30\text{ mA}$


Power gain G_{ma} , $G_{ms} = f(V_{CE})$

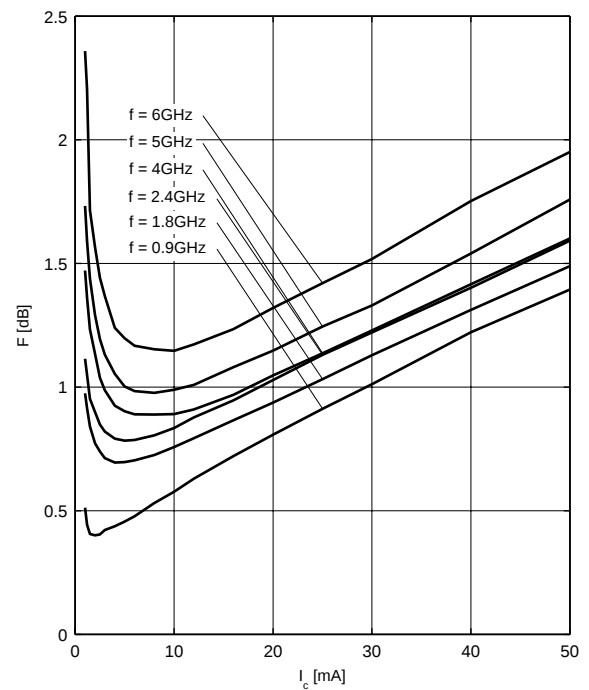
$I_C = 30\text{mA}$

$f = \text{parameter}$



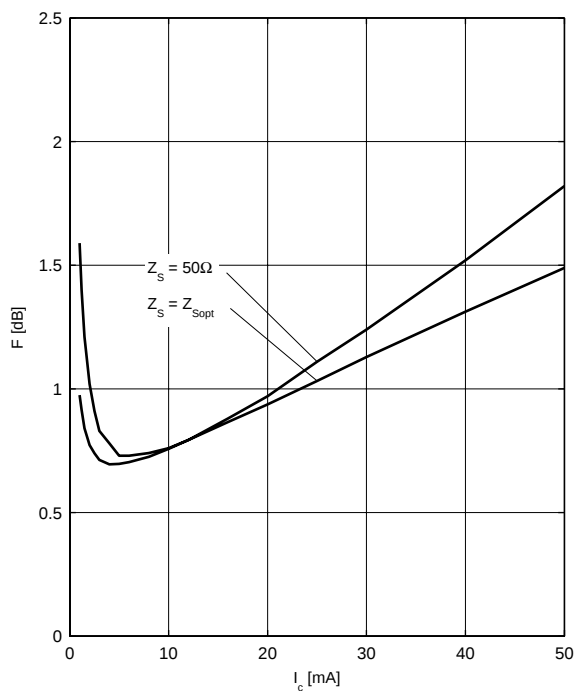
Noise figure $F = f(I_C)$

$V_{CE} = 3\text{V}$, $Z_S = Z_{Sopt}$



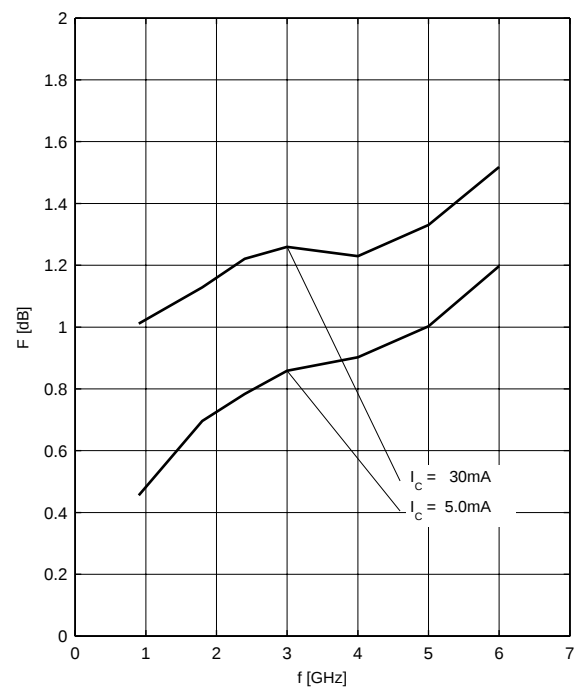
Noise figure $F = f(I_C)$

$V_{CE} = 3\text{V}$, $f = 1.8\text{ GHz}$



Noise figure $F = f(f)$

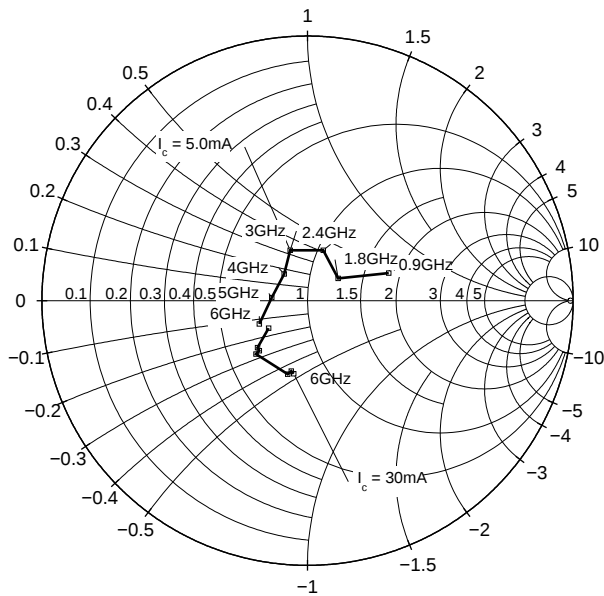
$V_{CE} = 3\text{V}$, $Z_S = Z_{Sopt}$



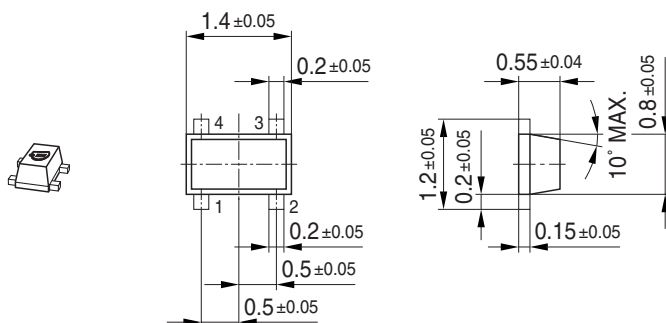
Source impedance for min.

noise figure vs. frequency

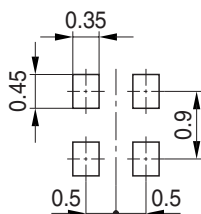
$V_{CE} = 3\text{ V}$, $I_C = 5\text{ mA}/30\text{ mA}$



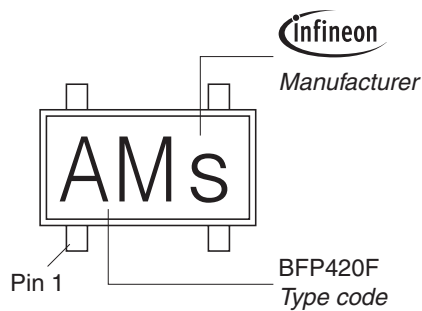
Package Outline



Foot Print

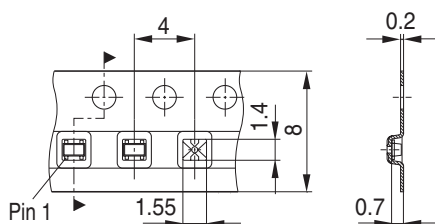


Marking Layout (Example)



Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel
 Reel ø330 mm = 10.000 Pieces/Reel



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